# **AMC7135**



### **350mA Advanced Current Regulator**

### DESCRIPTION

The AMC7135 is a low dropout current regulator rated for 350mA constant sink current. The low quiescent current and low dropout voltage are achieved by advanced Bi-CMOS process.

### **FEATURES**

- 350mA constant sink current.
- **Output short / open circuit protection.**
- Low dropout voltage.
- Low quiescent current
- Supply voltage range 2.7V ~ 6V
- **2KV HBM ESD protection**
- **Advanced Bi-CMOS process.**
- SOT-89 and TO-252 package

### TYPICAL APPLICATION CIRCUIT

### **APPLICATIONS**

2.7V ~ 6V VIN O VDD AMC7135 OUT GND C<sub>o</sub>'

\* C<sub>O</sub> is strongly recommended.

### Cap Lamp

**Refrigerator Lighting** 

Power LED driver



(Top View)

ORDER INFORMATION							
т	DK	SOT-89	ST	TO-252			
I <sub>OUT</sub>		3-pin	01	3-pin			
340-380mA		AMC7135PKF		AMC7135SJF			
300-340mA		AMC7135PKFA		AMC7135SJFA			
Note: 1. All surface-mount packages are available in Tape & Reel. Append the letter "T" to part number (i.e. AMC7135PKFAT).   2. The letter "F" is marked for Lead Free process.   3. The letter "A" is marked for current ranking.							

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ABSOLUTE MAXIMUM RATINGS (Note)					
Input Voltage, V <sub>DD</sub>	-0.3V to 7V				
Output Voltage, V <sub>OUT</sub>	-0.3V to 7V				
Maximum Junction Temperature, T <sub>J</sub>	150°C				
Storage Temperature Range	-40°C to 150°C				
Lead Temperature (Soldering, 10 seconds)	260°C				
Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of the specified terminal.					

BLOCK DIAGRAM							
VDD Band-gap Reference Control Circuit GND							

Pin Name	Pin Function
V <sub>DD</sub>	Power supply.
OUT	Output pins. Connected to load.
GND	Ground.

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RECOMMENDED OPERATING CONDITIONS							
Parameter	Symbol	Min	Тур	Max	Unit		
Supply Voltage	V <sub>DD</sub>	2.7		6	V		
Output Sink Current	I <sub>OUT</sub>			400	mA		
Operating Free-air Temperature Range	T <sub>A</sub>	-40		+85	°C		

### DC ELECTRICAL CHARACTERISTICS

$V_{DD}$ =3.7V, $T_A$ =25°C, No Load, (Unless otherwise noted)								
Parameter	Symbol	Condition Min Typ Max Unit		Unit	Apply Pin			
	I <sub>SINK</sub>	V <sub>OUT</sub> =0.2V	340	360	380	mA		
Output Sink Current		V <sub>OUT</sub> =0.2V, Rank A	300	320	340	mA		
Load Regulation		$V_{OUT}=0.2V$ to $3V$			3	mA/V	OUT	
Line Regulation		$V_{DD}$ = 3V to 6V, $V_{OUT}$ =0.2V			3	mA/V	001	
Output Dropout Voltage	V <sub>OUTL</sub>			120		mV		
Supply Current Consumption	I <sub>DD</sub>			200		uA	VDD	

Note 1: Output dropout voltage: 90% x  $I_{\text{OUT}}$  @  $V_{\text{OUT}} = 200 mV$ 

### TYPICAL OPERATION CHRACTERISTICS







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QUIESCENT CURRENT vs. TEMP

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#### **APPLICATION INFORMATION**

### **Output Capacitor Co and PCB layout:**

The output capacitor  $C_0$  may be removed under certain condition. Please refer to the following figure. If LED and AMC7135 is located in the same PCB, and the length of the routing path L1<10cm & L2<3cm, the output capacitor  $C_0$  can be neglected.



If LED and AMC7135 is located in separate PCBs, or the length of the routing path L1>10cm or L2>3cm, the output capacitor  $C_0$  should be added. Typically, capacitance of  $0.1 \text{uF} \sim 1 \text{uF}$  is recommended and 1 uF is needed when L2 is much longer than 3cm.



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### The Maximum Power Dissipation on Regulator:

 $P_{D(MAX)} = V_{OUT(MAX)} \times I_{OUT(NOM)} + V_{IN(MAX)} \times I_Q$ 

 $V_{OUT(MAX)}$  = the maximum voltage on output pin;

I<sub>OUT(NOM)</sub> = the nominal output current;

 $I_Q$  = the quiescent current the regulator consumes at  $I_{OUT(MAX)}$ ;

 $V_{IN(MAX)}$  = the maximum input voltage.

### **Thermal Consideration:**

The maximum junction temperature ratings of AMC7135 should not be exceeded under continuous normal load conditions. When power consumption is over about 700mW (SOT-89 package, at  $T_A=70^{\circ}$ C) or 1000mW (TO-252 package, at  $T_A=70^{\circ}$ C), additional heat sink is required to control the junction temperature below 120°C.

The junction temperature is:

 $T_{J} = P_{D} (\theta_{JT} + \theta_{CS} + \theta_{SA}) + T_{A}$ 

 $P_D$ : Dissipated power.

 $\theta$  JT: Thermal resistance from the junction to the mounting tab of the package.

For SOT-89 package,  $\theta_{JT} = 35.0 \,^{\circ}\text{C}$  /W. For TO-252 package,  $\theta_{JT} = 7.0 \,^{\circ}\text{C}$  /W.

 $\theta_{CS}$ : Thermal resistance through the interface between the IC and the surface on which it is mounted. (typically,  $\theta_{CS} < 1.0^{\circ}$ C/W)

 $\theta_{\rm SA}$ : Thermal resistance from the mounting surface to ambient (thermal resistance of the heat sink).

If PC Board copper is going to be used as a heat sink, below table can be used to determine the appropriate size of copper foil required. For multi-layered PCB, these layers can also be used as a heat sink. They can be connected with several through-hole vias.

PCB $\theta$ sa (°C/W)	59	45	38	33	27	24	21
PCB heat sink size (mm <sup>2</sup> )	500	1000	1500	2000	3000	4000	5000



#### Recommended figure of PCB area used as a heat sink.

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## AMC7135

### PACKAGE

### 3-Pin Surface Mount SOT-89

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### 3-Pin Surface Mount TO-252 (SJ)



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